

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Oliver HARNACK	07/02/2009
Jurina WESSELS	07/03/2009
Akio YASUDA	07/02/2009
James CLARKE	06/29/2009
Terry REID	06/29/2009

RECEIVING PARTY DATA

Name:	Sony Deutschland GmbH
Street Address:	Kemperplatz 1
City:	Berlin
State/Country:	GERMANY
Postal Code:	10783

Name:	Oxford Nanopore Technologies Limited
Street Address:	Begbroke Science Part, Sandy Lane
City:	Kidlington
State/Country:	UNITED KINGDOM
Postal Code:	OX5 1PF

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12409007

CORRESPONDENCE DATA

Fax Number: (703)413-2220

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Email: aassefa@oblon.com

Correspondent Name: Oblon, Spivak, et al.

OP \$40.00 12409007

500916141

PATENT  
REEL: 022986 FRAME: 0485

Address Line 1: 1940 Duke Street  
Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: 340090US8X

NAME OF SUBMITTER: Aynalem Assefa

Total Attachments: 8  
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Docket Number: 340090US8X

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name are listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in  
A METHOD OF FABRICATING A MEMBRANE HAVING A TAPERED PORE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Deutschland GmbH with offices at Kemperplatz 1, 10783, Berlin, Germany and Oxford Nanopore Technologies Limited with offices at Begbroke Science Park, Sandy Lane, Kidlington, OX5 1PF, United Kingdom (hereinafter referenced as ASSIGNEES) are desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or their designee, as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEES thereof shall hereafter require and prepare at their own expense;

And I further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 12/409,007  
Filing Date: March 23, 2009

This assignment executed on the dates indicated below.

Oliver HARNACK

Name of first or sole inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of first or sole inventor

  
Signature of first or sole inventor

2.7.2009

Date of this assignment

Jurina WESSELS

Name of second inventor

Execution date of U.S. Patent Application

Starnberg, Germany

Residence of second inventor

Signature of second inventor

Date of this assignment

Akio YASUDA

Name of third inventor

Execution date of U.S. Patent Application

Suginami-ku, Tokyo, Japan

Residence of third inventor

Signature of third inventor

Date of this assignment

James CLARKE

Name of fourth inventor

Execution date of U.S. Patent Application

Colchester, Essex, United Kingdom

Residence of fourth inventor

Signature of fourth inventor

Date of this assignment

Terry REID

Name of fifth inventor

Execution date of U.S. Patent Application

Bicester, Oxfordshire, United Kingdom

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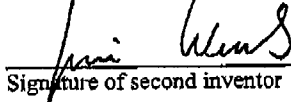
Jurina WESSELS

Name of second inventor

Execution date of U.S. Patent Application

Starnberg, Germany

Residence of second inventor



Signature of second inventor

03/02/09

Date of this assignment

Akio YASUDA

Name of third inventor

Execution date of U.S. Patent Application

Suginami-ku, Tokyo, Japan

Residence of third inventor

Signature of third inventor

Date of this assignment

James CLARKE

Name of fourth inventor

Execution date of U.S. Patent Application

Colchester, Essex, United Kingdom

Residence of fourth inventor

Signature of fourth inventor

Date of this assignment

Terry REID

Name of fifth inventor

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Signature of second inventor

Date of this assignment

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Name of third inventor

Execution date of U.S. Patent Application

Suginami-ku, Tokyo, Japan

Residence of third inventor

Akio Yasuda02/07/89

Signature of third inventor

Date of this assignment

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Name of fourth inventor

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Signature of fourth inventor

Date of this assignment

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Name of fifth inventor

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Name of third inventor

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Name of fourth inventor

Execution date of U.S. Patent Application

Colchester, Essex, United Kingdom

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Signature of fourth inventor

29/6/09.  
Date of this assignmentTerry REID

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Bicester, Oxfordshire, United Kingdom

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